TOSHIBA Photocoupler IRED & Photo-Triac

## **TLP160J**

Triac Drive Programmable Controllers AC-Output Module Solid State Relay

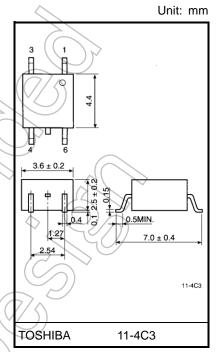
The TOSHIBA mini flat coupler TLP160J is a small outline coupler, suitable for surface mount assembly.

The TLP160J consists of a photo triac, optically coupled to an infrared emitting diode.

- Peak off-state voltage: 600 V (min)
- Trigger LED current: 10 mA (max)
- On-state current: 70 mA (max)
- Isolation voltage: 2500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A
   File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

Note 1: When a VDE approved type is needed,

please designate the Option(V4).



Weight: 0.09 g (typ.)

#### **Trigger LED Current**

Classification (Note 1)	Trigger LED C		
	V <sub>T</sub> =6V, Ta	Marking of Classification	
	Min	Max	
(IFT7)	× -	7.0	77
Standard	) }/	10	T7, blank

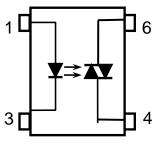
Note 1:Ex.(IFT7); TLP160J (IFT7)

Note: Application type name for certification test, please

use standard product type name, i.e.

TLP160J(IFT7): TLP160J

# Pin Configurations (top view)



- 1. Anode
- 3. Cathode
- 4. Triac Terminal
- 6. Triac Terminal

Start of commercial production 1988-04

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
	Forward current	lF	50	mA	
	Forward current derating (T	ΔI <sub>F</sub> / °C	-0.7	mA / °C	
	Peak forward current (100 µ	IFP	1	Á	
LED	Reverse voltage		VR	5	V (
	Diode power dissipation		PD	100	mW
	Diode power dissipation de	ΔP <sub>D</sub> /°C	-1.4	mW/°C	
	Junction temperature	Tj	125	(°C)	
	Off-state output terminal vo	VDRM	600	V	
	On-state RMS current	Ta=25°C	IT(DMO)	70	
		Ta=70°C	IT(RMS)	40	-mA
	On-state current derating (7	ΔI <sub>T</sub> / °C	-0.67	mA / °C	
Detector	Peak on-state current (100)	ITP	(7/2)	Α	
Dete	Peak nonrepetitive surge cu (P <sub>W</sub> =10ms)	ITSM	1.2	A <	
	Output power dissipation	Po	200	mW	
	Output power dissipation de	ΔP <sub>0</sub> /°C	-2.0	mW / °C	
	Junction temperature	Tj	115 ((	//°¢	
Storage temperature range			T <sub>stg</sub>	-55 to 125	~c/
Operating temperature range			Topr	-40 to 100	°C
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C
Isolatio	n voltage (AC, 60 s, R.H. ≤ 6	BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

## **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	VAC	_	_	240	Vac
Forward current	lF	15	20	25	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

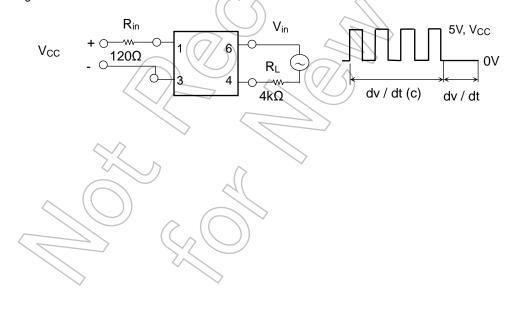
#### **Electrical Characteristics (Ta = 25°C)**

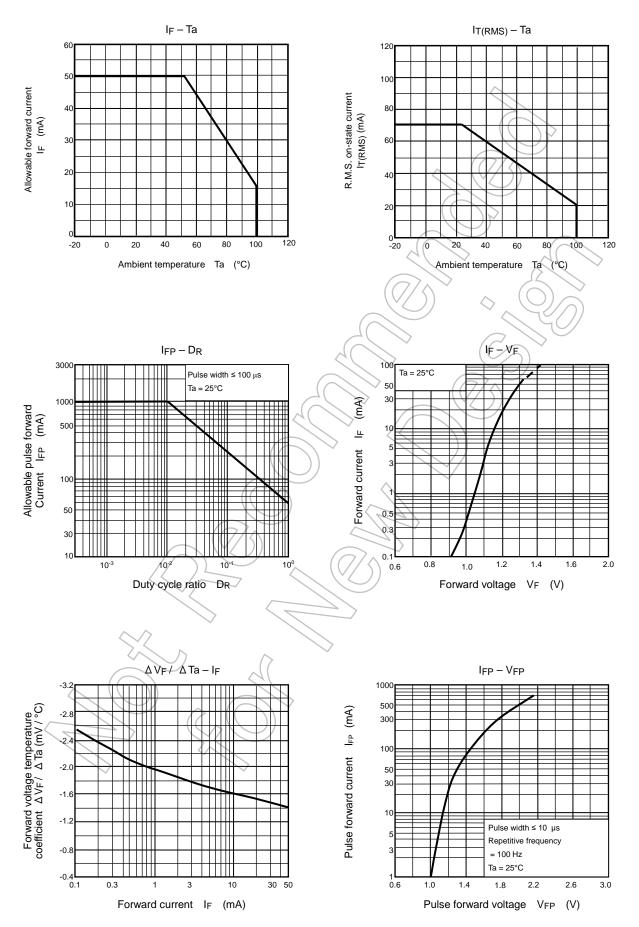
	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	Ст	VF = 0 V, f = 1 MHz	<u> </u>	30	_	pF
Detector	Peak off-state current	IDRM	VDRM = 600 V		10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 70 mA		1.7	2.8	V
	Holding current	lн	(7)	7(	1.0	_	mA
	Critical rate of rise of off-state voltage	dv / dt	V <sub>in</sub> = 240 Vrms, Ta = 85 °C (Fig.1)	<u>))</u>	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	I <sub>T</sub> = 15 mA, V <sub>in</sub> = 60 Vms (Fig.1)	_	0.2	_	V / µs

## **Coupled Electrical Characteristics (Ta = 25°C)**

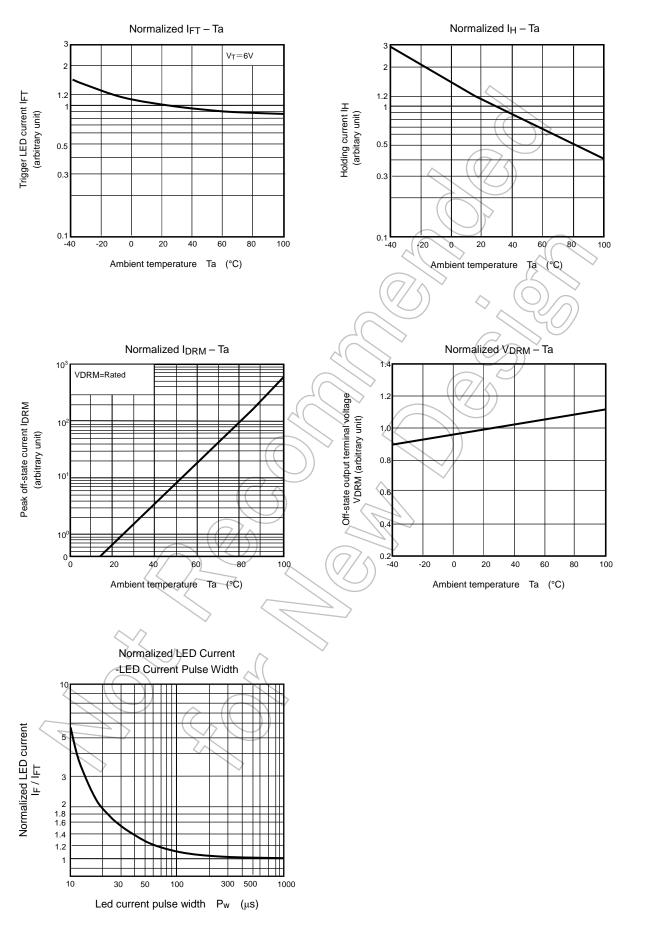
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>	VT = 6 V		5	10	mA
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz	( <del>-</del> )	0.8	_	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60 %	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	2500	_	_	Vrms
Turn-on time	ton	$V_D = 6\rightarrow 4 \text{ V, RL} = 100 \Omega$ If = rated IFT × 1.5	_	30	100	μs

Fig.1 dv / dt test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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